

- ◆ Femto second integrated phase jitter (200 fs typical, 12 KHz to 20 MHz)
- ◆ Superior phase noise (-138 dBc/Hz at 10 KHz and -144 dBc/Hz at 100 KHz offset).
- ◆ High performance with surprisingly low price.
- ◆ 2.5V or 3.3V supply voltage.





#### **General Specifications**

Product Series		HPK5361; "K" family characteristics. Tri-State on pad 1						
Frequency Range		40 MHz ~ 200 MHz.						
Output Logic	Differential PECL square wave							
		Stability Co	de		mercial " C ": C to +70°C		<b>ndustrial</b> " I ": 40°C to +85°C	
Frequency Stability		±25 ppm			Α		D	
		±50 ppm			В		E	
vs Operating Temper	ature	±100 ppm			С		F	
Range		Custom ±xx			Схх		lxx	
		If custom, use "temperature range code + desired stability in ppm" for the stability code. Example: "C20" (±20 ppm over -10 to +70°C).						
Supply Voltage V <sub>CC</sub>		+2.5 V ± 5	% (Voltage co	ode is " <b>25</b> "); (	or $+3.3 \text{ V} \pm 5$	% (Voltage o	code is "3")	
Output Voltage HIGH	"1", <b>V</b> OH	V <sub>DD</sub> -1.025 V min.; V <sub>DD</sub> -0.95 V typical; V <sub>DD</sub> -0.88 V max. Condition: 50 ohms to V <sub>DD</sub> -2V						
Output Voltage LOW	"0", <b>V</b> ol	V <sub>DD</sub> -1.810 V min.; V <sub>DD</sub> -1.70 V typical; V <sub>DD</sub> -1.62 V max. Condition: 50 ohms to V <sub>DD</sub> -2V						
Output Swing		595 mV min; 750 mV typical; 930 mV max.						
Current Consumption		35 mA typical; 50 mA max.						
Load		50 ohms into Vcc-2V or Thevenin equivalent (terminating resistors required on all outputs).						
Rise Time (Tr)		0.3 n sec. typ; 0.5 n sec. max. 20%→80% of waveform						
Fall Time (Tf)		0.3 n sec. typ; 0.5 n sec. max. 80%→20% of waveform						
Duty Cycle		50% ± 5% max. measured at 50% waveform						
Tri-state Function on pad No. 1		If no connection or V <sub>DD</sub> *70% min is applied: Output. Internal pull-up Oscillation disable time is 0.2 u sec max.  If V <sub>DD</sub> *30% max is applied: High impedance.						
		Current consumption is 10 uA typical						
Phase Jitter (RMS)		Oscillation enable time is 2 m sec. max.  200 fs typical (12 KHz to 20 MHz integrated)						
SSB Phase Noise	Offset	10 Hz	100 Hz	1 kHz	10 kHz	100 kHz	1 MHz	10 MHz
(dBc/Hz). Typical	125 MHz	-50	-82	-116	-138	-144	-149	-155
Start-up Time		3 ms typical; 10 m sec. max.						
Aging	Aging		±3 ppm / year max.					
Packaging		180 mm reel; 16 mm tape, 7.8 mm pitch. 1000 pcs per reel.						

(1)Inclusive of 25°C tolerance, operating temperature range, ±10% input voltage variation, load change, aging at +25°C, shock and vibration

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Absolute Maximum Rating Permanent damage may be created if operate beyond limits specified Ta=25°C, Vss=0V

Parameters	R	Rating		
Parameters	Min.	Max.		
Supply Voltage	Vss-0.5V	5.0V		
Input Voltage	Vss-0.5V	V <sub>DD</sub> +0.5V		
Output Voltage	Vss-0.5V	V <sub>DD</sub> +0.5V		

#### **Environmental Performance Specifications**

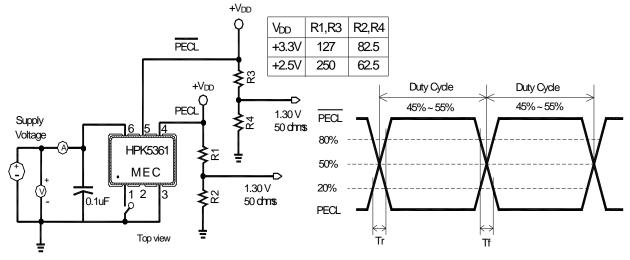
Green Requirement	RoHS 6/6 (2002/95/EC) and WEEE (2002/96/EC) compliant
MSL Level	Level 1 per IPC/JEDEC J-STD-020D.1
Storage temp. range	-55°C to +125°C
Humidity	85% RH, 85°C, 48 hours
Hermetic seal	Leak rate 2x10-8 ATM-cm <sup>3</sup> /sec max.
Solderability	MIL-STD-202F method 208E
Reflow	260°C for 10 sec max 2 times max.
Vibration	MIL-STD-202F method 204, 35G, 50 to 2000 Hz
Shock	MIL-STD-202F method 213B, test condi. E, 1000GG ½ sine wave
ESD Protection	2KV max. Human body model.
Contact pad surface finish	Gold (0.3~1.0 um) on nickel (1.27~8.89 um)
Weight per unit	160 mg typical

#### Part Number Format and Examples:

Exa	Example: 3HPK5361-A-155.520; 25HPK5361-A-155.520								
<b>Explanation</b> : +3.3V HPK5361 series LVPECL output clock oscillator, frequency stability is ±25 ppm over									
-10°	-10°C to +70°C, 155.520 MHz								
			Æ		Ø				
3	HPK5361	_	Α	_	155.520				
1	2		3		4				

①: V<sub>DD</sub> voltage codes: "3" for +3.3 V; "25" for +2.5 V ②: HPK5361 product series. 'H" for clock; "P" for PECL; "K": for "K" family characteristics. "536" for 3.2x5 mm SMD with 6 pads. '1" for Tri-State on pad 1.
③: Frequency stability code: "A" ~ "F" or custom. See table above. ④: Frequency in MHz

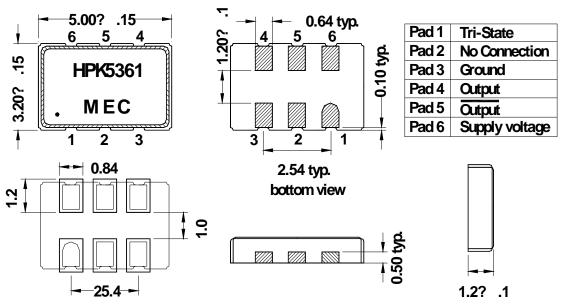
#### 25HPK5361 and 3HPK5361 Test Circuit and Waveform:



HPK5361 Package Dimensions and Recommended Solder Pad Layout: unit mm

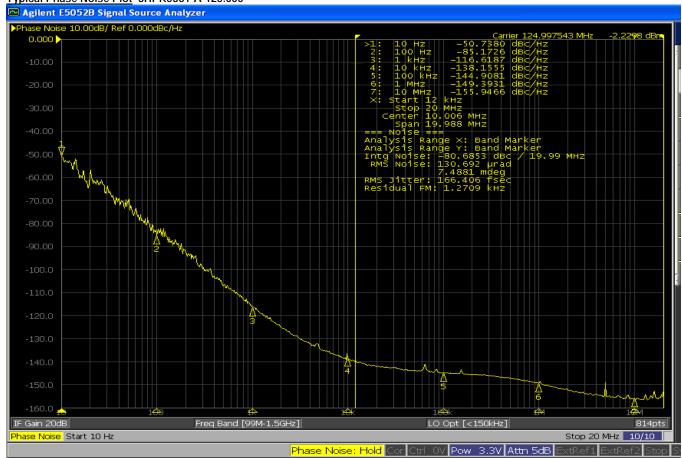
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Rounded pad is pad No. 1. Count counter-clockwise when looking at top view. Count clockwise when looking at bottom view.

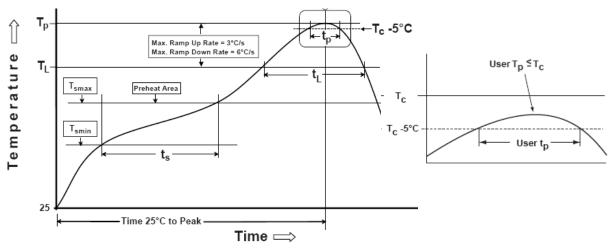




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<u>HPK5361 Recommended Solder Reflow Profile</u> (from\_IPC/JEDEC J-STD-020D.1)



Profile Feature	Sn-Pb Eutectic Assembly	Pb-free Assembly	
Preheat/Soak			
- Temperature min. (Ts min.)	100°C	150°C	
- Temperature max. (Ts max.)	150°C	200°C	
- Time (ts) (Ts min. to Ts max.)	60 to 120 seconds	60 to 180 seconds	
Ramp-up rate (T <sub>L</sub> to Tp)	3°C / sec. max.	3°C / sec. max.	
Liquidous temperature (T <sub>L</sub> )	183°C	217°C	
Time (t <sub>L</sub> ) maintained above T <sub>L</sub>	60 to 150 seconds	60 to 150 seconds	
Peak package body temperature (Tp)	235°C	260°C	
Time (Tp) within 5°C of the classification temperature Tc	10 to 30 seconds	20 to 40 seconds	
Ramp-down rate (Tp to T <sub>L</sub> )	6°C / second max.	6°C / second max.	
Time 25°C to peak temperature	6 minutes max.	8 minutes max.	

All temperatures refer to topside of the package, measured on the package body surface.

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